TOSHIBA Field Effect Transistor Silicon P, N Channel MOS Type (U-MOS III / π -MOS VI)

TPCP8401

- O Switching Regulator Applications
- C Load Switch Applications
- Lead(Pb)-Free
- Multi-chip discrete device; built-in P channel MOS FET for main switch and N Channel MOS FET for drive
- Small footprint due to small and thin package
- Low drain-source ON resistance : P Channel RDS (ON) = $31 \text{ m}\Omega$ (typ.)
- Low drain-source ON resistance High forward transfer admittance : P Channel $|Y_{fs}| = 13$ S (typ.)
- Low leakage current : P Channel IDSS = $-10 \mu A (VDS = -12 V)$
- Enhancement-mode : P Channel V_{th} = -0.5 to -1.2 V (V_{DS} = -10 V, I_D = -200 µA)

Absolute Maximum Ratings (Ta = 25°C)

P-ch

| Characte | ristics | Symbol | Rating | Unit |
|---------------------------|-----------------------------|------------------|--------|------|
| Drain-source voltage | | V _{DSS} | -12 | V |
| Drain-gate voltage (R | t _{GS} = 20 kΩ) | V _{DGR} | -12 | V |
| Gate-source voltage | | V _{GSS} | ±8 | V |
| Drain current | DC (Note 1) | ID | -5.5 | А |
| Drain current | Pulse (Note 1) | I _{DP} | -22.0 | A |
| Drain power dissipation | on (t = 5 s) (Note 2a) | PD | 1.96 | W |
| Drain power dissipation | on (t = 5 s) (Note 2b) | PD | 1.0 | W |
| Single pulse avalanch | ne energy (Note 3) | E _{AS} | 5.3 | mJ |
| Avalanche current | | I _{AR} | -2.8 | А |
| Repetitive avalanche (| energy Note 2a) (Note 4) | E _{AR} | 0.22 | mJ |
| Channel temperature | | T _{ch} | 150 | °C |



Weight: 0.017 g (typ.)

Circuit Configuration



Marking (Note5)



N-ch

| Characteristics | | | Symbol | Rating | Unit | |
|--|---------------------|----------|------------------|--------|------|--|
| Drain-source v | voltage | | V _{DSS} | 20 | V | |
| Gate-source v | oltage | | V _{GSS} | ±10 | V | |
| Drain current | DC | (Note 1) | ۱ _D | 0.1 | А | |
| | Pulse | (Note 1) | I _{DP} | 0.2 | A | |
| Channel temp | Channel temperature | | | 150 | °C | |
| Repetitive avalanche energy Single-device value at dual operation (Note 2a, 3b, 5) | | | E _{AR} | 0.12 | mJ | |
| Channel temperature | | | T _{ch} | 150 | °C | |

This transistor is an electrostatic-sensitive device. Handle with caution.

Common Absolute Maximum Ratings (Ta=25°C)

| Characteristics | Symbol | Rating | Unit |
|---------------------------|------------------|---------|------|
| Storage temperature range | T _{stg} | -55~150 | °C |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

| Characteristics | Symbol | Max | Unit |
|--|------------------------|------|------|
| Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2a) | R _{th (ch-a)} | 63.8 | °C/W |
| Thermal resistance, channel to ambient $(t = 5 s)$ (Note 2b) | R _{th (ch-a)} | 125 | °C/W |

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: (a) Mounted on FR4 board (glass epoxy, 0.8mm thick, Cu area: 25.4mm2) (t = 5s) (b) Mounted on FR4 board (glass epoxy, 0.8mm thick, printed minimum pad dimensions: 25.4mm2) (t = 5s)

Note 3: $V_{DD} = -10 \text{ V}, \text{ T}_{ch} = 25^{\circ}\text{C}$ (initial), L = 0.5 mH, R_G = 25 Ω , I_{AR} = -2.75 A

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: "●" on the lower left of the marking indicates pin 1. "*" shows the lot number, which consists of three digits. The first digit denotes the year of manufacture, expressed as the last digit of the calendar year; the next two digits denote the week of manufacture.



Week of manufacture – (01 for the first week of year, continuing up to 52 or 53)

Year of manufacture

(The last digit of the calendar year)

Electrical Characteristics (Ta = 25°C)

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| Cha | aracteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--|---------------|----------------------|--|------|------|------|------|
| Gate leakage current | | I _{GSS} | $V_{GS} = \pm 8 \text{ V}, V_{DS} = 0 \text{ V}$ | _ | | ±10 | μA |
| Drain cut-off curr | ent | I _{DSS} | $V_{DS} = -12 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | _ | | -10 | μA |
| Drain-source breakdown voltage | | V (BR) DSS | $I_D = -10$ mA, $V_{GS} = 0$ V | -12 | | | v |
| | andown vonage | V (BR) DSX | $I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$ | -4 | | _ | v |
| Gate threshold ve | oltage | V _{th} | $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -200 \mu\text{A}$ | -0.5 | | -1.2 | V |
| | | | $V_{GS} = -1.8 \text{ V}, I_D = -1.4 \text{ A}$ | _ | 66 | 103 | |
| Drain-source ON | resistance | R _{DS (ON)} | $V_{GS}=-2.5$ V, $I_{D}=-2.8$ A | — | 44 | 58 | mΩ |
| | | | $V_{GS}=-4.5 \text{ V}, \text{ I}_{D}=-2.8 \text{ A}$ | | 31 | 38 | |
| Forward transfer admittance | | Y _{fs} | $V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.8 \text{ A}$ | 6.5 | 13 | _ | S |
| Input capacitance | | C _{iss} | | _ | 1520 | _ | |
| Reverse transfer | capacitance | C _{rss} | $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{MHz}$ | _ | 330 | | pF |
| Output capacitan | се | C _{oss} | | | 380 | | |
| | Rise time | tr | $V_{GS} \xrightarrow{0}_{-5} V$ $I_{D} = -2.8 A$ G | — | 9.5 | — | |
| Switching time | Turn-on time | t _{on} | | _ | 16 | | ns |
| Switching time | Fall time | t _f | | _ | 28 | _ | 115 |
| | Turn-off time | t _{off} | 000 = 000 Duty≦ 1%, t _w = 10 μs | _ | 74 | _ | |
| Total gate charge (gate-source plus gate-drain) | | Qg | $V_{DD} \simeq -10 \text{ V}, \text{ V}_{GS} = -5 \text{ V},$ | | 20 | _ | |
| Gate-source charge 1 | | Q _{gs1} | $I_{\rm D} = -5.5 \rm{A}$ | | 15 | | nC |
| Gate-drain ("miller") charge | | Q _{gd} | | _ | 5 | — | |

Source-Drain Ratings and Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|--|------------------|----------------------------------|-----|------|-----|------|
| Drain reverse current (pulse) (Note 1) | I _{DRP} | _ | _ | _ | -22 | А |
| Forward voltage (diode) | V _{DSF} | $I_{\rm DR}$ = -5.5 A, VGS = 0 V | | | 1.2 | V |

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| Cha | racteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|------------------------------|----------------|-----------------------------------|---|-----|------|-----|------|
| Gate leakage current | | IGSS | V_{GS} = ±10 V, V_{DS} = 0 V | | | ±1 | μA |
| Drain cut-off current | | IDSS | V _{DS} = 20 V, V _{GS} = 0 V | | — | 1 | μA |
| Drain-source brea | akdown voltage | $V\left(_{BR}\right)\mathrm{DSS}$ | I _D = 0.1 mA, V _{GS} = 0 V | 20 | _ | | V |
| Gate threshold vo | ltage | V_{th} | V _{DS} = 3 V, I _D = 0.1 mA | 0.6 | _ | 1.1 | V |
| | | | V _{GS} = 1.5 V, I _D = 1 mA | | 5.2 | 15 | Ω |
| Drain-source ON | resistance | RDS (ON) | V _{GS} = 2.5 V, I _D = 10 mA | _ | 2.2 | 4 | |
| | | | V _{GS} = 4 V, I _D = 10 mA | _ | 1.5 | 3 | |
| Forward transfer admittance | | $ Y_{\rm fs} $ | V _{DS} = 3 V, I _D = 10 mA | 40 | _ | _ | mS |
| Switching time | Turn-on time | t _{on} | $V_{GS} \overset{2.5 \text{ V}}{}_{0 \text{ V}} \prod_{\substack{I_D = 10 \text{ mA} \\ \bigcirc \text{ V}_{OUT}}} 0 \text{ V}_{OUT} - 0 $ | _ | 70 | _ | |
| | Turn-off time | t _{off} | | | 125 | | ns |
| Input capacitance | | C _{iss} | | | 9.3 | | |
| Reverse transfer capacitance | | C _{rss} | V _{DS} = 3 V, V _{GS} = 0 V, f = 1 MHz | _ | 4.5 | | pF |
| Output capacitance | | C _{oss} |] | _ | 9.8 | — | |

Precaution

 $V_{th} \ \text{can be expressed as the voltage between the gate and source when the low operating current value is I_D = 100 \ \mu\text{A} \ \text{for this product.} \ \text{For normal switching operation}, V_{GS} \ \text{(on)} \ \text{requires a higher voltage than} \ V_{th} \ \text{and} \ V_{GS} \ \text{(off)} \ \text{requires a lower voltage than} \ V_{th}.$ (The relationship can be established as follows: $V_{GS} \ \text{(off)} < V_{th} < V_{GS} \ \text{(on)}.$)

Be sure to take this into consideration when using the device. The V_{GS} recommended voltage for turning on this product is 1.5 V or higher.

Pch





Drain-source voltage V_{DS} (V)























Safe operating area



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Ambient temperature

Ta (°C)

Ambient temperature

Ta (°C)









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